

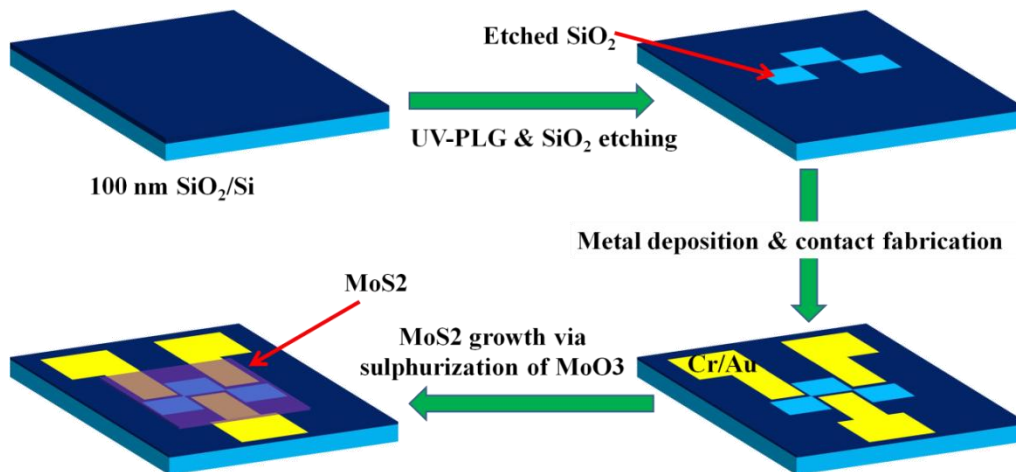
# High-Speed Scalable Silicon-MoS<sub>2</sub> P-N Heterojunction Photodetectors

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**Fig.S1 Schematic fabrication process of MoS<sub>2</sub>-Si p-n junction photodetector**

For the fabrication of MoS<sub>2</sub>-Si heterojunction 100 nm SiO<sub>2</sub> has been grown on p-Si wafer. A two step photo-lithography process was used to define the heterojunction area, in which SiO<sub>2</sub> was etched. Buffered oxide (buffered HF) etchant was used for the etching of SiO<sub>2</sub>. After the etching of SiO<sub>2</sub>, metal contacts of Cr/Au were fabricated by etching process. 10 nm thick



chromium (Cr) and 50 nm thick gold (Au) stacks were deposited by RF sputtering, which would be used as electrodes. A second photo-lithography process followed by wet etching of metals (Cr and Au) has been carried out after the deposition. Thin layer of MoO<sub>3</sub> (10 nm) was on the samples deposited by reactive sputtering. After the deposition of MoO<sub>3</sub> sulphurization process has been carried to synthesize MoS<sub>2</sub> thin film.

## Structural characterization:

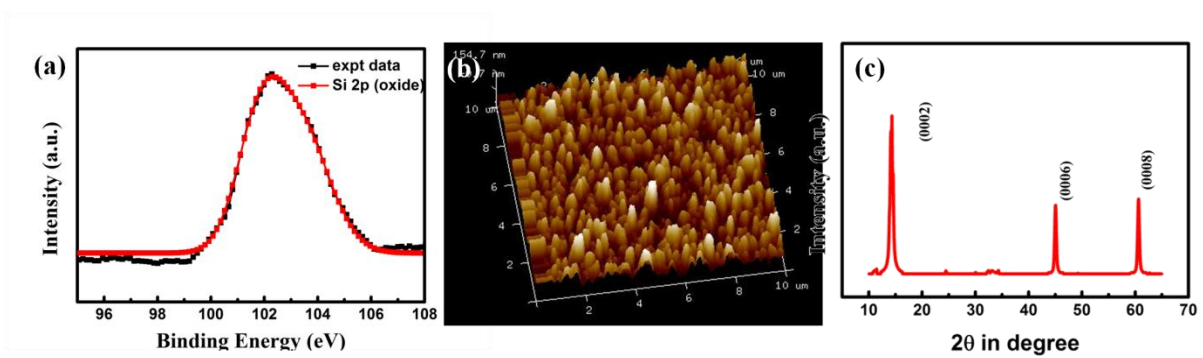


Fig. S2 (a) XPS Spectra showing the binding energy of Si (for oxide), The binding energy observed from the Fig. S2 (a) shows the oxide formation of Si. That was originated due to oxide on Si surface. Formation of Mo-silicide was not observed from the XPS analysis of Mo and Si. The morphology of MoS<sub>2</sub> was composed of vertically aligned nanoflakes with average width of between 20-40 nm, which remains nearly same on SiO<sub>2</sub> also (Fig. S2(b)). The XRD spectra (shown in the Fig (S2 (c)) shows the growth direction of MoS<sub>2</sub> is along (0002), (0006) and (0008) crystal planes. These peaks correspond to the c-axis growth of hexagonal planes.

## J-V plot and C-V of the MoS<sub>2</sub>-Si heterojunction

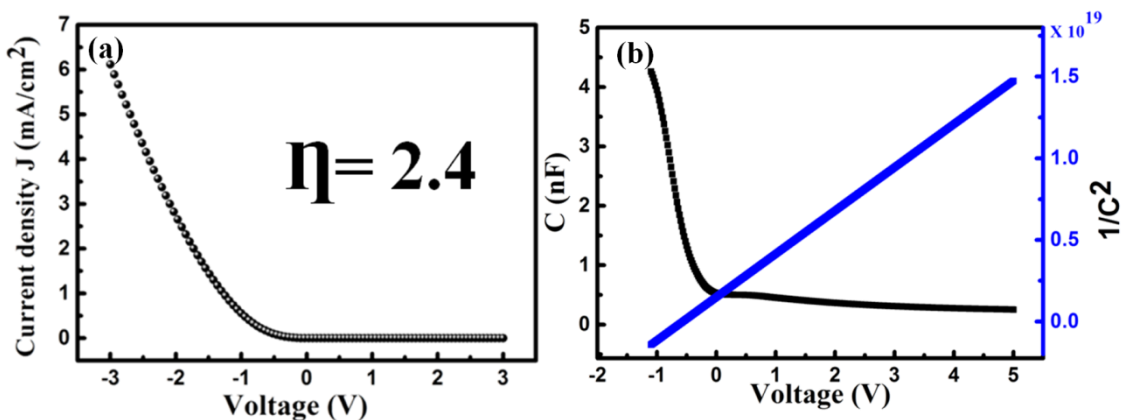


Fig. S3 (a) The extracted Ideality factor from Current density-Voltage plot was found to be  $\sim 2.4$  for MoS<sub>2</sub>-Si heterojunction. Fig.S3 (b) Capacitance-Voltage plot of MoS<sub>2</sub>-Si heterojunction The C-V measurement of this heterojunction has been carried out Fig.S3 (b). The doping concentration for MoS<sub>2</sub> of  $\sim 2 \times 10^{16} \text{ cm}^{-3}$  was extracted for C-V analysis. In the I-

V and C-V measurement the p-Si was kept grounded and the bias voltage was given on the top n-MoS<sub>2</sub> contact. Thus for a positive bias voltage the junction becomes reverse biased.

**MSM device with one ohmic contact (low work function)**

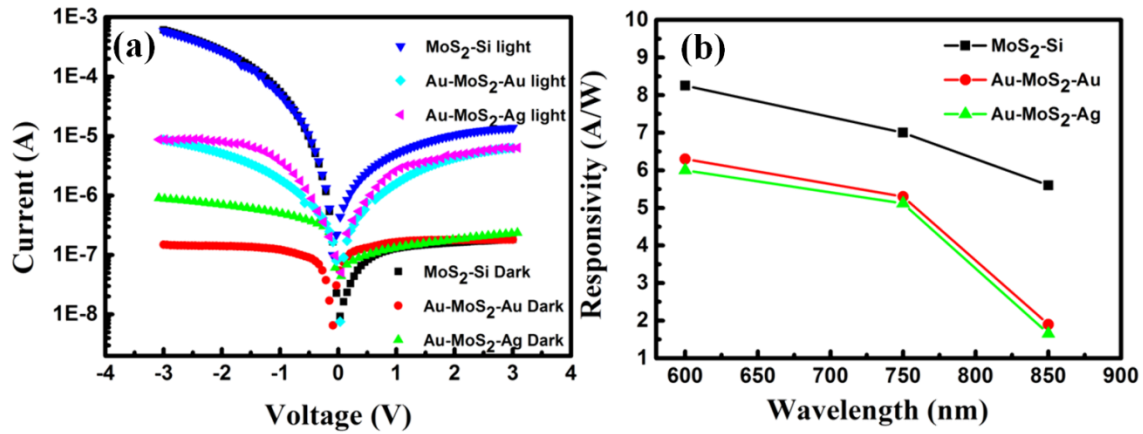


Fig. S4 (a) IV-Characteristics (dark and Light) and (b) responsivity of MoS<sub>2</sub>-Si heterojunction, Au-MoS<sub>2</sub>-Au MSM and Au-MoS<sub>2</sub>-Ag MSM Photodetectors are clearly shows the high gain in MoS<sub>2</sub>-Si heterojunction over other two MSM devices. The comparison photoresponse characteristics of Au-MoS<sub>2</sub>-Au MSM and Au-MoS<sub>2</sub>-Ag MSM Photodetectors with Si-MoS<sub>2</sub> heterojunction are shown in Fig S4. Smaller rectification in Au-MoS<sub>2</sub>-Ag MSM device indicates lower barrier height at Au-MoS<sub>2</sub> interface. Also the photo-gain in the both device is nearly same. From these results it can be easily noted that the MoS<sub>2</sub>-Si heterojunction possess larger gain than the MoS<sub>2</sub> MSM photodetector. For longer wavelength gain is even much higher for MoS<sub>2</sub>-Si heterojunction compare to MSM devices.

## Transient measurements

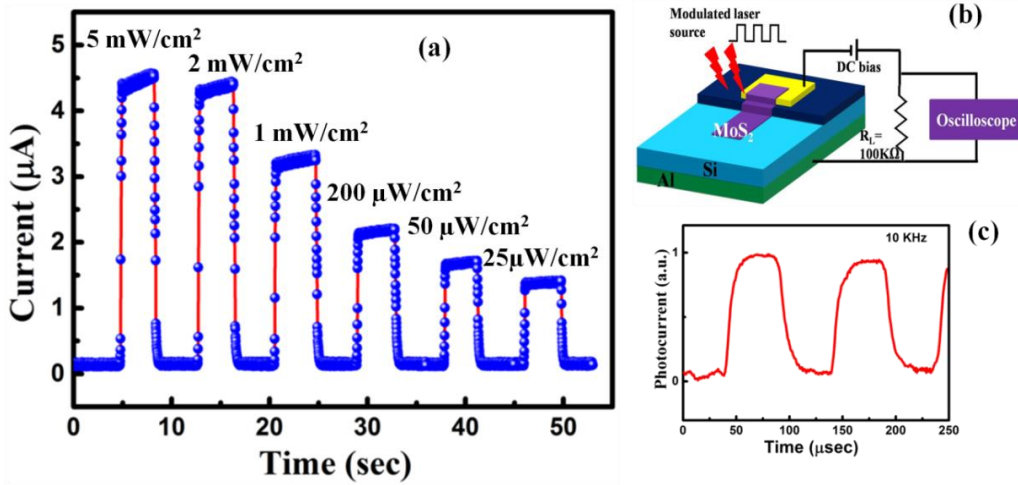


Fig. S5. (a) Transient measurement of Si/MoS<sub>2</sub> heterojunction photodetector under different illumination powers, (b) schematic diagram of time response measurements and (c) time response of Si/MoS<sub>2</sub> heterojunction photodetector under 10 kHz modulated light

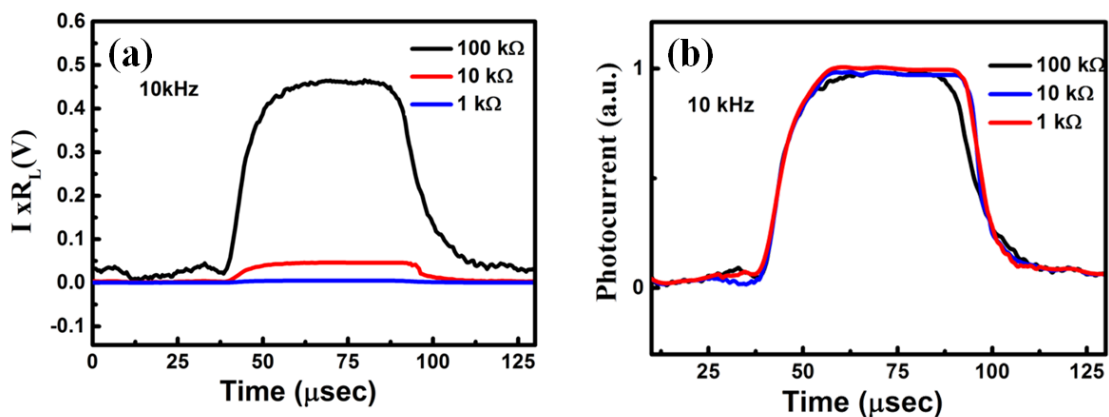


Fig. S6. Transient measurements of Si/MoS<sub>2</sub> heterojunction photodetector for different load resistances, Fig. (a) Shows the voltage across the resistances and (b) shows the normalized of photocurrent. Transient measurement for different load resistance shows that for smaller resistance small improvement in the response time was observed. However use of low resistance makes the signal very small, which is difficult to detect. Thus a load resistance of 100K $\Omega$  was used. Further increasing the load resistance will increase the time constant.

## Scalability measurements in as Synthesized MoS<sub>2</sub>

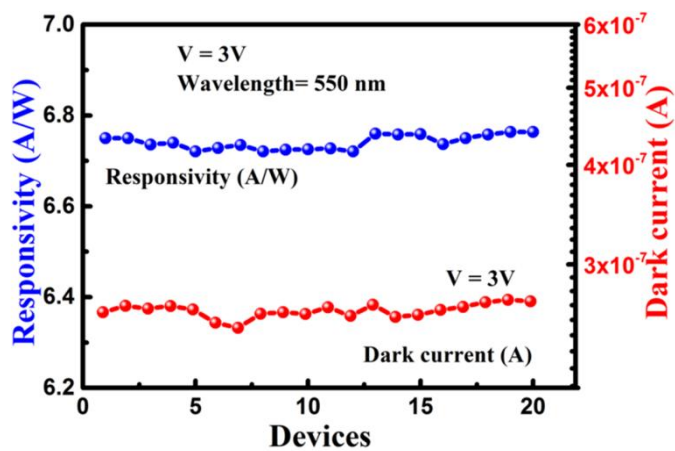


Fig. S7. The scalability of as synthesized MoS<sub>2</sub> the responsivity and dark current measurement for the 20 different active areas on same substrate are shown in Fig S7 (supplementary information).